



New Product

Si4394DY
 Vishay Siliconix

N-Channel Reduced Q_{gd} , Fast Switching WFET™

PRODUCT SUMMARY

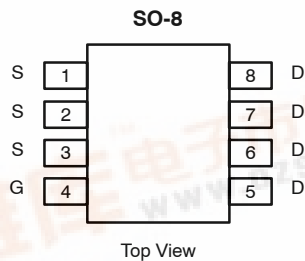
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.00825 @ $V_{GS} = 10$ V	15
	0.00975 @ $V_{GS} = 4.5$ V	14

FEATURES

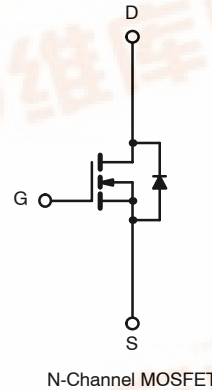
- Extremely Low Q_{gd} WFET™ Technology for Switching Losses
- TrenchFET® Power MOSFET
- 100% R_g Tested

APPLICATIONS

- High-Side DC/DC Conversion
 - Notebook
 - Server
- Synchronous Rectification



Ordering Information: Si4394DY—E3 (Lead Free)
 Si4394DY-T1—E3 (Lead Free with Tape and Reel)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	10 secs	Steady State	Unit
Drain-Source Voltage	V_{DS}	30		V
Gate-Source Voltage	V_{GS}	± 12		
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	15	10	A
		12	8	
Pulsed Drain Current (10 μs Pulse Width)	I_{DM}	50		
Continuous Source Current (Diode Conduction) ^a	I_S	2.7	1.3	
Avalanch Current	i_{AS}	45		
Maximum Power Dissipation ^a	P_D	2.7	1.4	W
		1.9	0.9	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	R_{thJA}	32	42	$^\circ\text{C/W}$
		68	90	
Maximum Junction-to-Foot (Drain)	R_{thJF}	16	20	

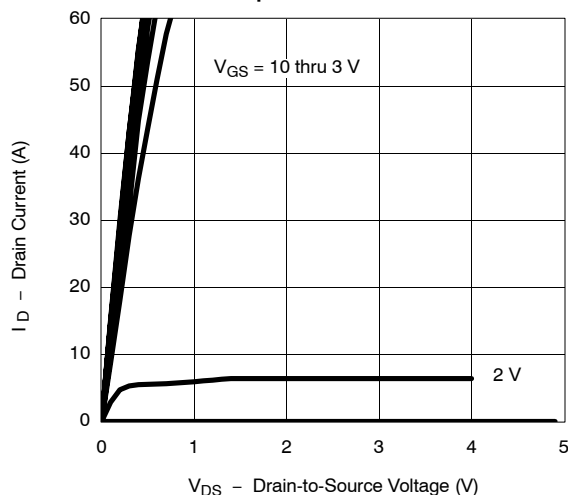
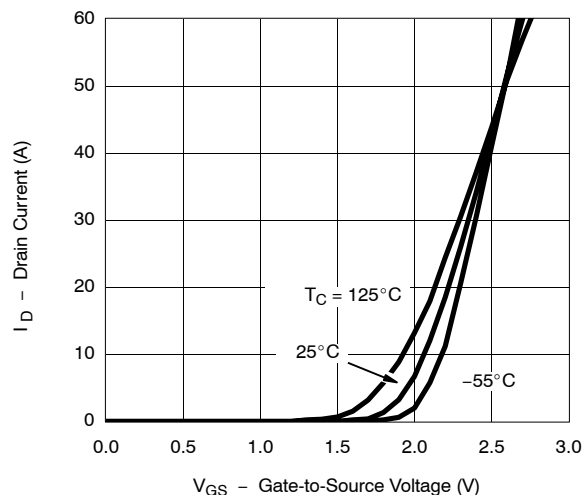
Notes:
 a. Surface Mounted on 1" x 1" FR4 Board.

Si4394DY**Vishay Siliconix****New Product****SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	0.6		1.8	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 12\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\ \text{V}$, $V_{GS} = 0\ \text{V}$			1	μA
		$V_{DS} = 30\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 55^\circ\text{C}$			5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}$, $V_{GS} = 10\ \text{V}$	30			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\ \text{V}$, $I_D = 15\ \text{A}$		0.0066	0.00825	Ω
		$V_{GS} = 4.5\ \text{V}$, $I_D = 14\ \text{A}$		0.0077	0.00975	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\ \text{V}$, $I_D = 15\ \text{A}$		65		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.9\ \text{A}$, $V_{GS} = 0\ \text{V}$		0.73	1.1	V
Dynamic^b						
Input Capacitance	C_{iss}	$V_{DS} = 15\ \text{V}$, $V_{GS} = 0\ \text{V}$, $f = 1\ \text{MHz}$		1900		pF
Output Capacitance	C_{oss}			530		
Reverse Transfer Capacitance	C_{rss}			120		
Total Gate Charge	Q_g	$V_{DS} = 15\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 15\ \text{A}$		12.5		nC
Gate-Source Charge	Q_{gs}			3.9		
Gate-Drain Charge	Q_{gd}			2.1		
Gate Resistance	R_g	$f = 1\ \text{MHz}$	0.8	1.2	1.8	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\ \text{V}$, $R_L = 15\ \Omega$ $I_D \cong 1\ \text{A}$, $V_{GEN} = 10\ \text{V}$, $R_g = 6\ \Omega$		13	20	ns
Rise Time	t_r			8	13	
Turn-Off Delay Time	$t_{d(off)}$			48	75	
Fall Time	t_f			13	20	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 2.9\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$		36	55	

Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**Output Characteristics****Transfer Characteristics**

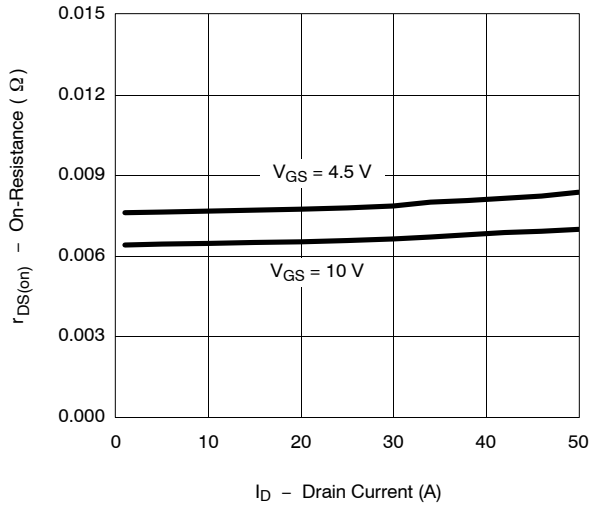


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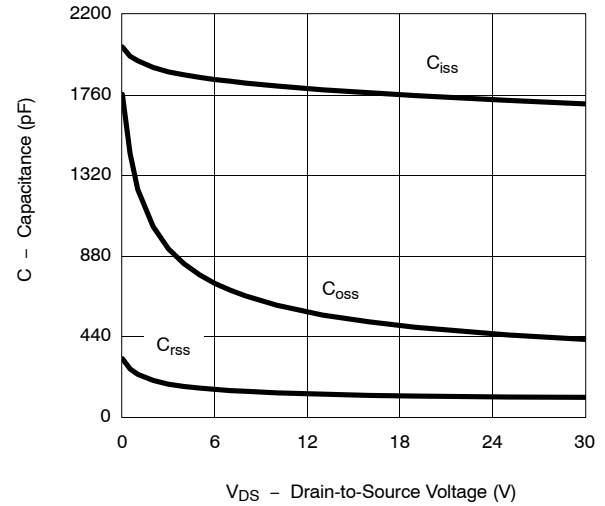
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Vishay Siliconix

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

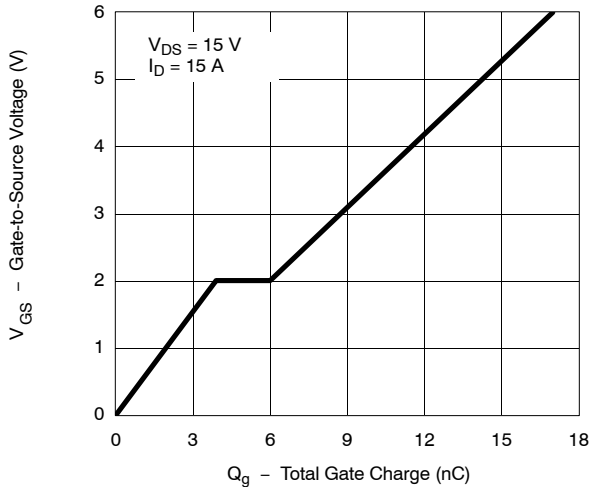
On-Resistance vs. Drain Current



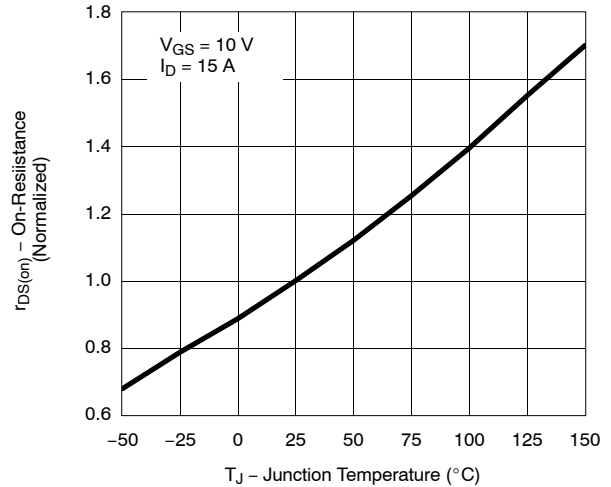
Capacitance



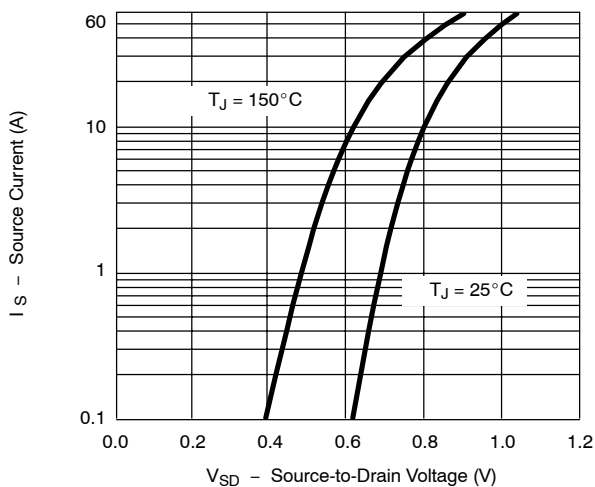
Gate Charge



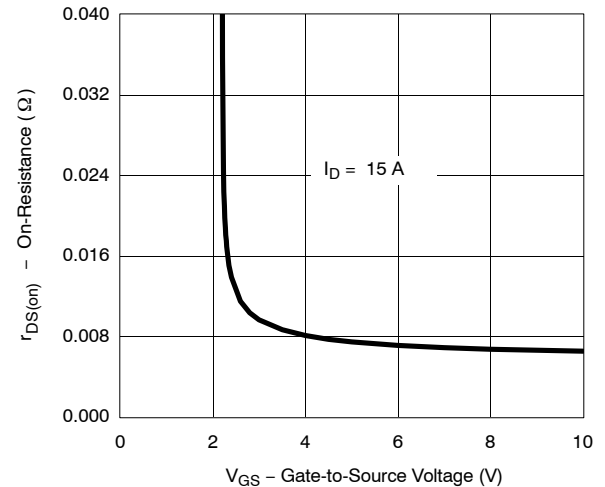
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



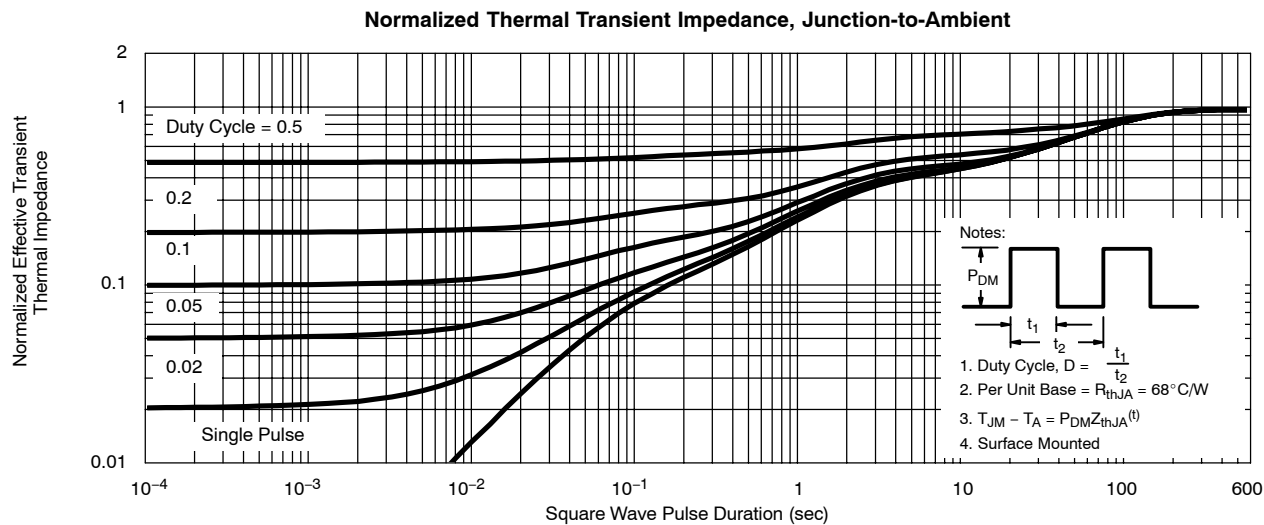
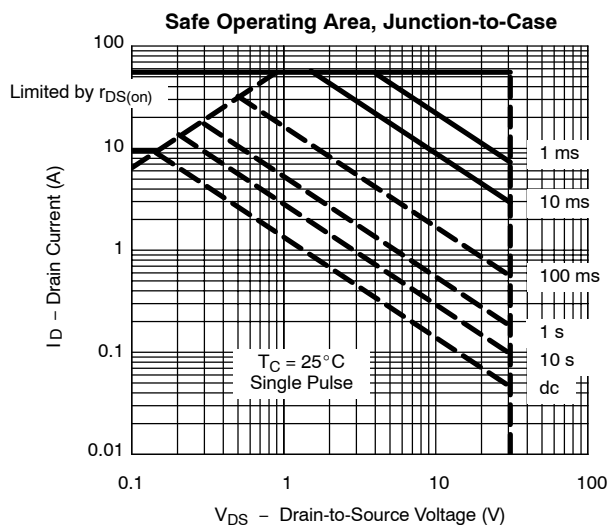
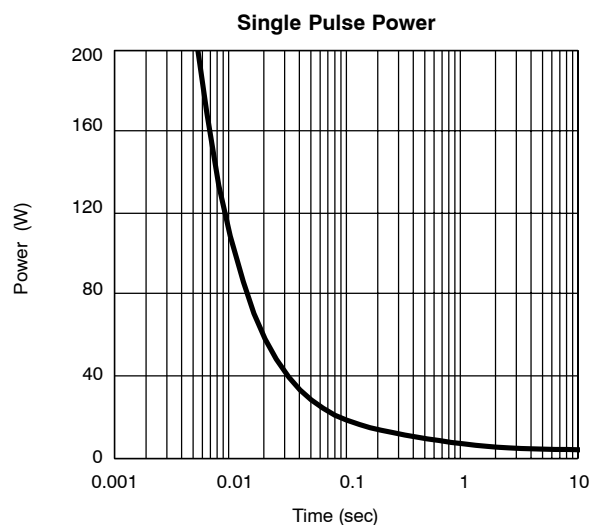
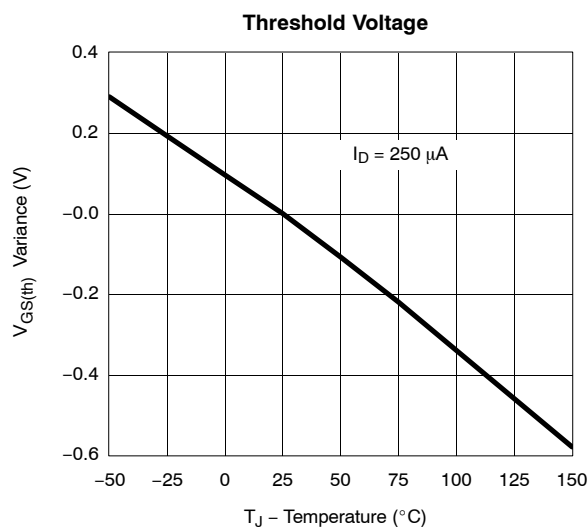
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